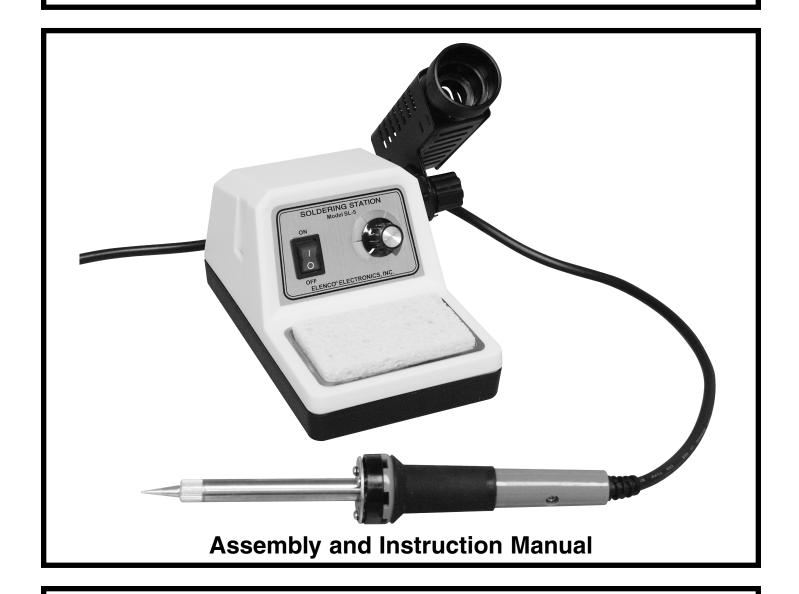
DELUXE ELECTRONIC SOLDERING STATION KIT

MODEL SL-5K MODEL SL-5K-40 MODEL SL-5K-SPL



Elenco[®] Electronics, Inc.

SOLDERING STATION KIT MODELS

These instructions are for the following electronic soldering stations. The model number of the electronic soldering station that you have received, is marked on the end of the carton.

☐ **Model SL-5K** is supplied without an iron.

☐ **Model SL-5K-40** is supplied with a 40 watt soldering iron, grounded plug, Model SR-6.

■ Model SL-5K-SPL is custom packaged with an iron of your choice of 25 to 60 watts, and other soldering

aids. A separate packing slip of the additional items will be enclosed.

INTRODUCTION

The SL-5 series of soldering stations are quality products designed to give the professional, student and hobbyist greater control in quality soldering a broad range of soldering situations. The stations are

available with variable wattage irons. The AC receptacle on the back of the station allows soldering irons of up to 300 watt. The AC receptacle also allows irons to be easily changed or replaced.

FEATURES

- Regulation of Temperature
- Non-Slip Base
- Iron Holder Reversible, left or right side
- Stainless Steel Tray for Sponge Pad
- Sponge Pad
- Power On/Off with Indicator Light

SAFETY PRECAUTIONS

Like all electrical devices, the solder station must be handled with care. The soldering iron and tip can reach high temperatures and these simple safety rules should be followed.

- Keep children out of reach of the soldering station.
- To protect your eyes, use safety goggles.
- Keep flammable material away from the soldering iron.
- <u>DO NOT cool iron</u> by dipping it into any liquid or water.

- Always assume that the tip is hot to avoid burns.
- Work in an area that is well ventilated.
- Be careful that the hot soldering iron tip or the barrel of the iron does not come in contact with any electrical cord.
- Do not hold solder in your mouth. Wash your hands thoroughly after handling solder.
- Locate soldering iron in an area where you do not have to go around it or reach over it.

INTRODUCTION TO SOLDERING

Almost every electronic device today has a printed circuit board. Whether you are assembling a PC board or repairing it, you must understand the basics of working with these boards.

A poorly soldered joint can greatly affect small current flow in circuits and can cause equipment failure. You can damage a PC board or a component with too much heat or cause a cold solder joint with insufficient heat. Sloppy soldering can cause bridges between two adjacent foils preventing the circuit from functioning.

Good soldering requires practice and an understanding of soldering principles. This solder practice project will help you achieve good soldering techniques, help you to become familiar with a variety of electronic components, and provide you with dynamic results. If the circuit has been assembled and soldered properly, two LEDs will alternately flash.

Solder

There are two basic types of solder used in the electronics industry today. They are solder with lead and lead-free solder. They both do the same job of fusing electrical connections, but have slightly different melting characteristics.

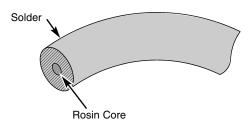


Figure 1

Lead-type solder has been the most common for years and is composed of tin and lead. The common ratios are 63/37 and 60/40. The first number is for tin and the second is lead. This solder has a melting point temperature of 360° to 370°. It is recommended that the soldering iron tip temperature be between 600°-700°F.

Lead-free solder is the solder of the future and is recommended for all future uses in soldering applications. The two common lead-free solders are LF96 and LF99. LF99 indicates the presence of 99% tin. The melting point of lead-free is 422°-440°F. It is recommended that the soldering iron tip temperature be between 700°-800°F.

Flux

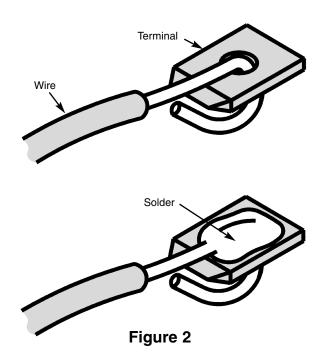
Most solder contains flux in the hollow core of the solder allowing it to be applied automatically when you heat the solder. The flux will remove any oxide film on the metals soldered creating a good metal-tometal contact. This is called "wetting the metal". There are three types of solder fluxes: chloride, organic and rosin. In the electronics industry, only the rosin type is used. Rosin flux comes in two types, pure and active. The most reliable is the pure type. since it doesn't cause dendrites between tracks on the PC board as the active type does. Due to the and moisture highly corrosive attracting characteristics of the chloride and organic type fluxes, they should not be used in electronics.

Surface Preparation

In order for the solder to adhere to the connection, the metals must be clean and free of nonmetallic materials. Flux in the solder can remove oxides from metal but not other materials like dirt or grease. To remove these, use a small steel brush or fine emery cloth.

Mechanical Connection

When all the surfaces are clean, the metals should have a solid mechanical connection. Wires should be tightly wrapped around each other or to the terminal. This will eliminate large gaps that create weak solder joints. Solder should not be used as a mechanical connection.



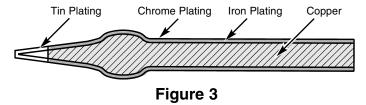
Types of Soldering Devices

A number of different types of soldering devices: irons, guns and stations are available today. Irons are used for light to medium work and guns are for medium to heavy-duty work. The station type can range from light to heavy-duty For working on PC boards, irons ranging from 15 to 40 watts are suitable, or a station with a range of 15 to 40 watts. If you use an iron with a higher wattage rating than 40 watt, you may damage the copper tracks on the PC board. The higher wattage irons are best suited for heavy-duty electrical jobs.

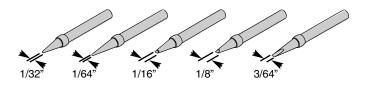


Solder Tips

The tip is the very important part of the iron. The material that the tip is made from is an essential factor. The soldering iron tip contains four different metals as shown in Figure 3. The core consists of copper. Since the copper is a soft material, it is plated with iron. Chrome plating is used on the area where no soldering takes place to prevent oxidation. Then the tip is plated with tin, because it can be easily cleaned.



Today, tips are manufactured in a variety of different shapes (see figure below). The chisel shape is one of the most common. Having a choice of tip styles allows you to choose the one best suited for your soldering needs. Due to the high heat, removable tips can bond themselves to the heating element if left in place for extended periods of time. Periodic removal of the tip is therefore advisable.



Tip Cleaning

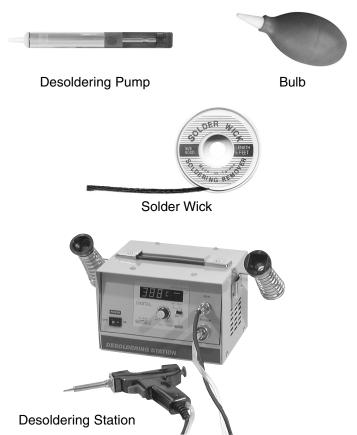
A good clean solder tip makes soldering much easier. The tip should be tinned by lightly coating it with solder to prevent it from oxidizing. The tip can become pitted (black spots) from normal use. It is important to clean the tip by wiping it with a wet sponge or rag. For tips that need a good cleaning, the tip tinner and cleaner (#TTC1) should be used. Never use a file or abrasive material to clean the tip. Using such methods will damage the plating and ruin the tip. Do not remove the excess solder from the tip before storing. The excess solder will prevent oxidation.

Clean Connections

Proper solder adhesion requires that the metal surface to be free of dirt and grease. The flux only removes the oxides so a brush or rag can be used to clean metal. There are contact cleaners in aerosol cans and other solvents available.

Desoldering

Great care should be taken when repairing or correcting a mistake on a PC board. The metal foil can be easily pulled up or broken from excessive heat. Use the least amount of heat as possible. You can use a desoldering tool, bulb, wick or a station. These tools will remove the solder enabling you to correct the problem.



SOLDERING

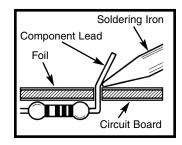
A poorly soldered joint can greatly affect small current flow in circuits and can cause equipment failure. You can damage a PC board or a component with too much heat or cause a cold solder joint with insufficient heat. Sloppy soldering can cause bridges between two adjacent foils preventing the circuit from functioning.

What Good Soldering Looks Like

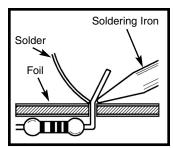
A good solder connection should be bright, shiny, smooth, and uniformly flowed over all surfaces.

Soldering a PC board

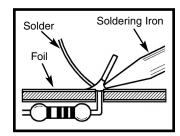
1. Solder all components from the copper foil side only. Push the soldering iron tip against both the lead and the circuit board foil.



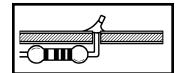
Apply a small amount of solder to the iron tip.
 This allows the heat to leave the iron and onto the foil. Immediately apply solder to the opposite side of the connection, away from the iron. Allow the heated component and the circuit foil to melt the solder.



3. Allow the solder to flow around the connection. Then, remove the solder and the iron and let the connection cool. The solder should have flowed smoothly and not lump around the wire lead.

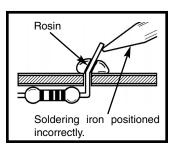


4. Here is what a good solder connection looks like.

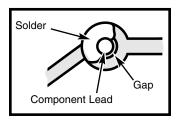


Types of Poor Soldering Connections

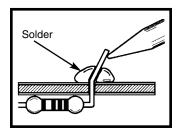
1. **Insufficient heat** - the solder will not flow onto the lead as shown.



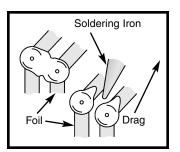
2. **Insufficient solder** - let the solder flow over the connection until it is covered. Use just enough solder to cover the connection.



3. **Excessive solder** - could make connections that you did not intend to between adjacent foil areas or terminals.



4. Solder bridges - occur when solder runs between circuit paths and creates a short circuit. This is usually caused by using too much solder. To correct this, simply drag your soldering iron across the solder bridge as shown.



Heat Sinking

Electronic components such as transistors, IC's, and diodes can be damaged by the heat during soldering. Heat sinking is a way of reducing the heat on the components while soldering. Dissipating the heat can be achieved by using long nose pliers, an alligator clip, or a special heat dissipating clip. The heat sink should be held on the component lead between the part and the solder joint.

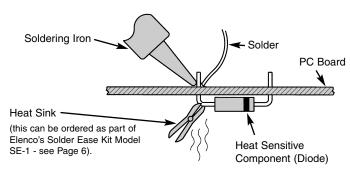
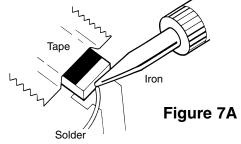


Figure 6

Soldering Surface Mount Components

1. Using tweezers, place the surface mount component on the PC board pads and secure in place with tape (see Figure 7A).



- 2. Apply a small amount of solder to the soldering iron tip. This allows the heat to leave the iron and flow onto the foil.
- 3. Place the iron in contact with the PC board foil. Apply a small amount of solder simultaneously to the foil and the component and allow them to melt the solder.
- 4. Remove the iron and allow the solder to cool. The solder should have flowed freely and not lump up around the component.
- 5. Remove the tape and solder the other side of the component.

When soldering the transistors, diodes and integrated circuits, the following procedure may be used:

- 1. Place the component on the PC board pads and secure in place with tape.
- 2. Apply a small amount of solder to the soldering iron tip.
- Place the soldering iron tip on top of the component lead to be soldered and apply solder simultaneously to the lead and the PC board foil.
- 4. Remove the iron and allow the solder to cool. The solder should have flowed freely and not lump up around the component.

After a component is completely soldered, each solder joint should be inspected with a magnifying glass. If the solder has not flowed smoothly, a bad solder joint is indicated. This occurs when the component and pad have not been heated sufficiently. To correct, reheat the connection and if necessary add a small amount of additional solder.

Another way to solder surface mount components is as follows:

- 1. Apply a small amount of solder to the soldering iron tip as shown in Figure 7B.
- 2. Using tweezers, hold the component on the PC board pads.
- 3. Apply the soldering iron simultaneously to the component and pad and allow the solder to flow around the component.
- 4. Remove the soldering iron and allow the connection to cool.

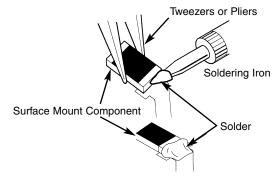


Figure 7B

CIRCUIT OPERATION

THYRISTOR

A thyristor is a controlled silicon diode which is not conductive in the reversed direction. It will only conduct in the forward direction when they are triggered by short pulse or steady voltage applied between the gate and cathode terminals (see Figure 8).

A thyristor family of semiconductors consists of several useful devices. The most commonly used are silicon-controlled rectifiers (SCR), triacs, and diacs. They can be thought of as a solid-state switch with three or more PN junctions.

TRIAC

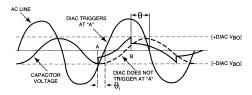
The block construction of a triac is shown in Figure 9. The triac is like two SCRs connected in parallel in the opposite direction. The construction of the triac allows it to conduct in either polarity. The triac has only one gate that can be triggered by either polarity. The main function is to control power bilaterally in an AC circuit.

DIAC

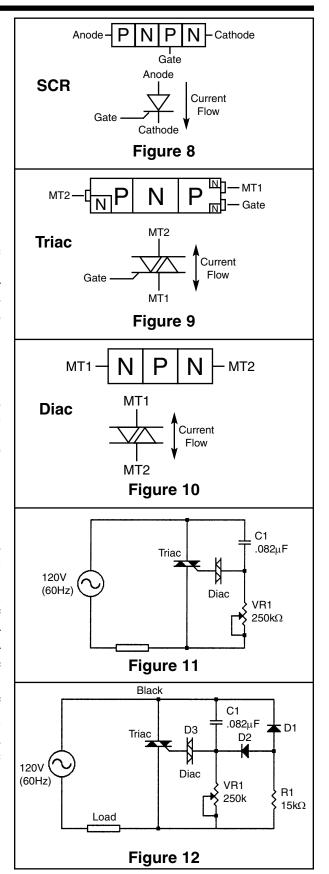
The block construction of a diac or bi-directional diode is shown in Figure 10. The diac will not conduct in either direction until its "breakover voltage" (V_{BO}) is exceeded. Breakover points range from 20-36 volt. When this accrues, the device will conduct until the voltage across its terminals is below the "breakback voltage" (V_{BB}) typical 6V.

CIRCUIT OPERATION

The circuit in Figure 11 is a basic full-wave triac phase control circuit. The variable resistor VR1 and capacitor C1 are a single-element phase shift network. When the voltage across C1 reaches break-over voltage of the diac D3, C1 is then partially discharged by the diac into the triac gate. The triac is then triggered (turned on) and conducts for the remainder of the half-cycle. The problem with this circuit is hysteresis, or snap back effect. The circuit will not operate until the resistor VR1 is turned up to an intermediate point. As the resistance of VR1 is decreased, the voltage across the capacitor C1 increases until the diac first fires at point A, the end of the half cycle. After the gate is triggered the capacitor voltage drops suddenly to approximately half the trigger voltage, causing a different initial condition. The capacitor charges to the diac trigger voltage at point B in the next half cycle.



The addition of resistor R1 and diodes D1 and D2 in Figure 12 will eliminate the hysteresis problem. The additional parts reset the timing capacitor to the same level after each positive half cycle. This provides a uniform initial condition for the timing capacitor.



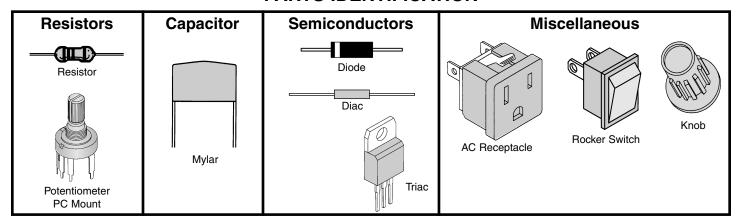
PARTS LIST

If you are a student, and any parts are missing or damaged, please see instructor or bookstore.

If you purchased this kit from a distributor, catalog, etc., please contact Elenco® Electronics (address/phone/e-mail is at the back of this manual) for additional assistance, if needed. **DO NOT** contact your place of purchase as they will not be able to help you.

			RESIST	ORS					
Qty.	Symbol	Description							
□ 1	R1	Resistor 15kΩ 5% 1/4W (brown-green-orange-gold)							
□ 1	VR1	Potentiometer 250kΩ PC Mount							
	CAPACITORS								
Qty.	Symbol	Description				Part #			
□ 1	C1	.082μF 200V Mylar				248219			
			SEMICOND	UCTOF	RS				
Qty.	Symbol	Description				Part #			
□2	D1, D2	1N4004				314004			
□ 1	TR1	Triac BTA12400	B / BTA08400B			364012			
□ 1	D3	Diac DB3				365761			
1			MISCELLA	NEOU:	3				
Qty.	Description		Part #	Qty.	Description	Part #			
□ 1	PC Board		517003	□ 1	Iron Holder Cap	680034			
□ 1	Switch Rocker Illuminated		541204	□ 1	Iron Holder Clip	680035			
□ 1	Tray		610801	□ 1	Iron Holder Screw	680036			
□ 1	Base		612205	□ 1	Label Front	723020A			
□ 1	Sponge		620003	□ 1	Label Bottom	723121A			
□ 1	Knob Push-on		622002	□ 1	Label Back	723022			
□ 1	Body Plastic		623033	□ 1	Wire 20AWG Black Topcoat 4"	813111			
□ 1	AC Receptacle)	627004	□ 1	Wire 20AWG Red Topcoat 4"	813120			
□ 1	Cable Tie	628982	□ 1	Wire 20AWG White Topcoat 4"	813190				
□ 4	Screw M15 X	4 Phillips	642109	□1	Line Cord Round 3 Wire	862107			
□1	Nut Pot	644010	□ 2"	1/4" Shrink Tubing	890701				
□ 1	Washer Pot	645015	□ 1 ½	" 3/4" Shrink Tubing	899110				
□ 4	Rubber Feet S	662020	□ 1	Solder Tube Lead-Free	9LF99				
□ 1	Iron Holder Bo	680033							

PARTS IDENTIFICATION

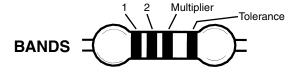


IDENTIFYING RESISTOR VALUES

Use the following information as a guide in properly identifying the value of resistors.

BANI 1st D		BAND 2 2nd Digit			Multiplier		
Color	Digit	Color	Digit	П	Color	Multiplier	
Black	0	Black	0		Black	1	
Brown	1	Brown	1	П	Brown	10	
Red	2	Red	2	П	Red	100	
Orange	3	Orange	3	ı	Orange	1,000	
Yellow	4	Yellow	4	П	Yellow	10,000	
Green	5	Green	5	Н	Green	100,000	
Blue	6	Blue	6	l	Blue	1,000,000	
Violet	7	Violet	7	Ш	Silver	0.01	
Gray	8	Gray	8		Gold	0.1	
White	9	White	9	ľ			

	Resistance Tolerance					
	Color	Tolerance				
	Silver	<u>+</u> 10%				
	Gold	<u>+</u> 5%				
	Brown	<u>+</u> 1%				
	Red	<u>+</u> 2%				
	Orange	<u>+</u> 3%				
	Green	<u>+</u> .5%				
	Blue	<u>+</u> .25%				
	Violet	<u>+</u> .1%				
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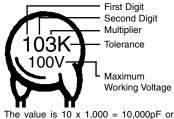


IDENTIFYING CAPACITOR VALUES

Capacitors will be identified by their capacitance value in pF (picofarads), nF (nanofarads), or μ F (microfarads). Most capacitors will have their actual value printed on them. Some capacitors may have their value printed in the following manner.

The letter M indicates a tolerance of $\pm 20\%$ The letter K indicates a tolerance of $\pm 10\%$ The letter J indicates a tolerance of $\pm 5\%$

Note: The letter "R" may be used at times to signify a decimal point; as in 3R3 = 3.3

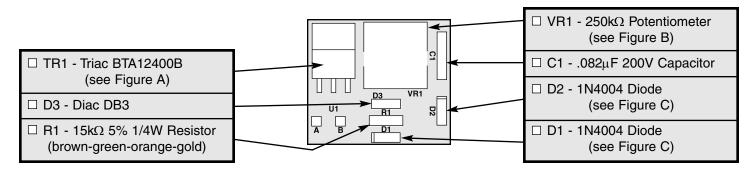


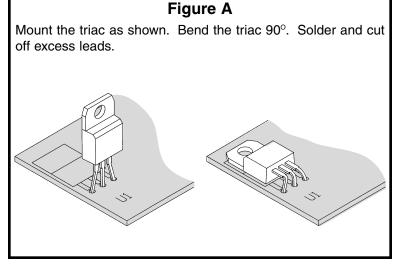
Multiplier	For the No.	0	1	2	3	4	5	8	9
	Multiply By	1	10	100	1k	10k	100k	.01	0.1

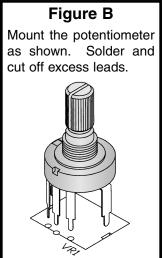
.01μF 100V

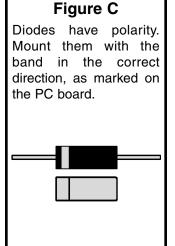
ASSEMBLE COMPONENTS TO THE PC BOARD

Care must be given to identifying the proper components and in good soldering habits. Place a check mark in the box after each step is complete.



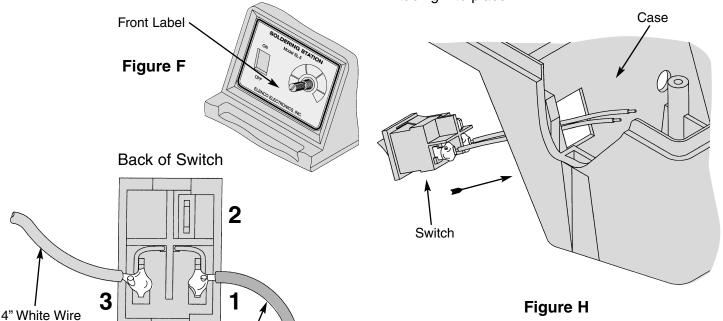






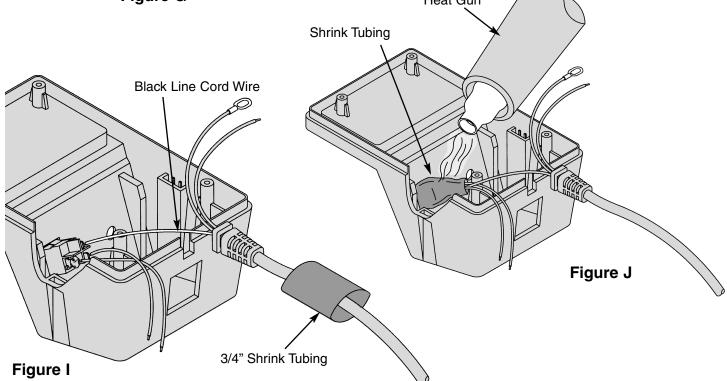
SWITCH ASSEMBLY

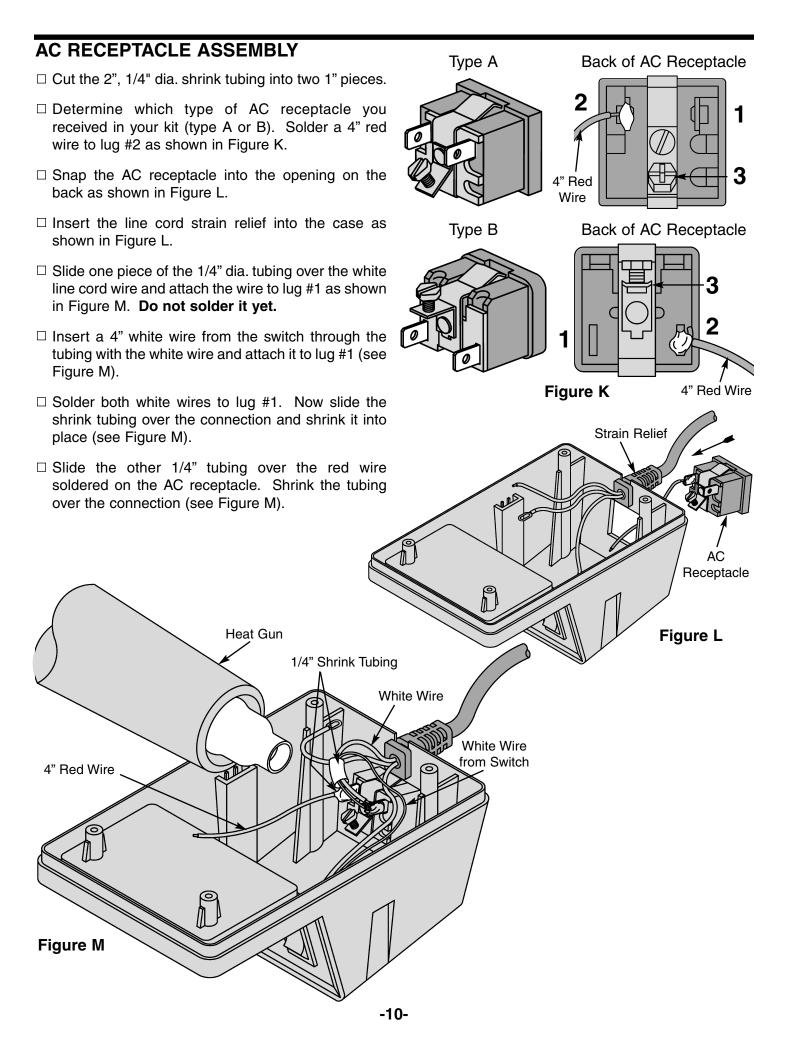
- □ Apply the front label to the case as shown in Figure F.
- □ Solder a 4" white wire to lug #3 as shown in Figure G.
- □ Solder a 4" black wire to lug #1 as shown in Figure G.
- ☐ Insert the switch into the opening on the front as shown in Figure H.
- □ Strip the insulation off the black and white line cord wires to expose 1/2" of bare wire if needed.
- ☐ Slip the 3/4" dia. shrink tubing over the line cord as shown in Figure I.
- □ Solder the black line cord wire to the #2 lug as shown in Figure I. Make sure the tubing is away from the soldering iron, so it will not shrink.
- ☐ Slip the shrink tubing over the wires and switch as shown in Figure J.
- ☐ Use a heat gun or hair dryer and shrink all of the tubing into place.



4" Black Wire

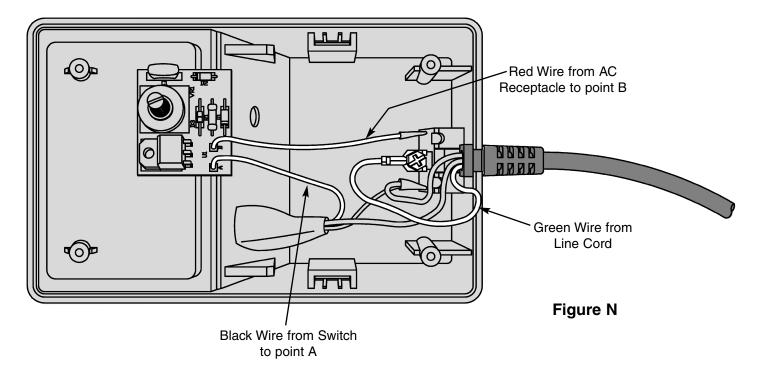
Heat Gun





SOLDERING WIRES TO THE PC BOARD (see Figure N)

- □ Solder the black wire from the switch to point A on the PC Board.
- □ Solder the red wire from the AC receptacle to point B on the PC Board.
- □ Remove the ground screw on the AC receptacle. Place the lug on the green wire from the line cord under the screw and tighten it.

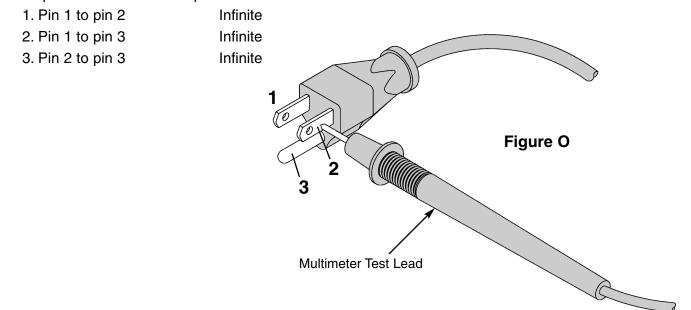


TESTING (see Figure O)

If you do not have a multimeter continue to page 12.

Check wiring if your readings are different.

☐ Set the power switch to the off position. Use a multimeter and measure the resistance as listed:

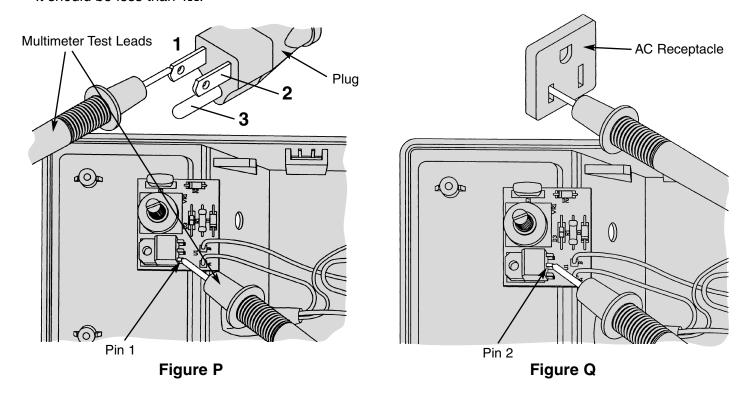


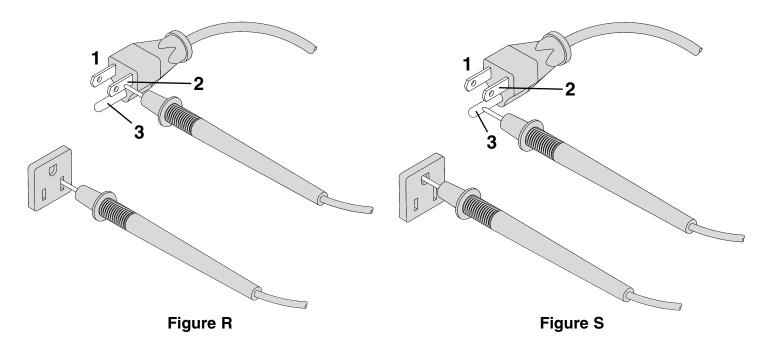
Check your wiring if your readings are different.

☐ Measure the resistance from pin #1 of the plug to pin 1 of SCR on the PC board as shown in Figure P.

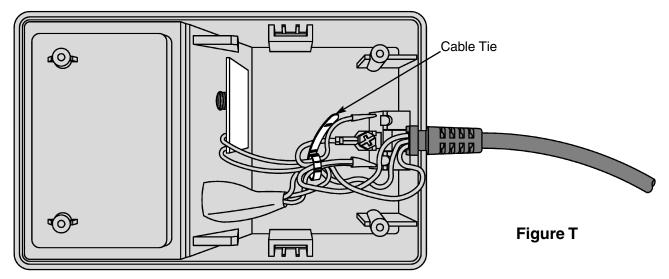
Switch set to OFF Infinite Switch set to ON less than 1Ω

- \Box Measure the resistance from pin 2 of SCR on the PC Board to pin #2 (Hot Side) of the AC receptacle as shown in Figure Q. It should be less than 1Ω .
- \Box Measure the resistance from pin #2 of the plug to pin #1 (Neutral side) of the AC receptacle as shown in Figure R. It should be less than 1Ω .
- \square Measure the resistance from pin #3 of the plug to pin #3 (GND) of the AC receptacle as shown in Figure S. It should be less than 1Ω .

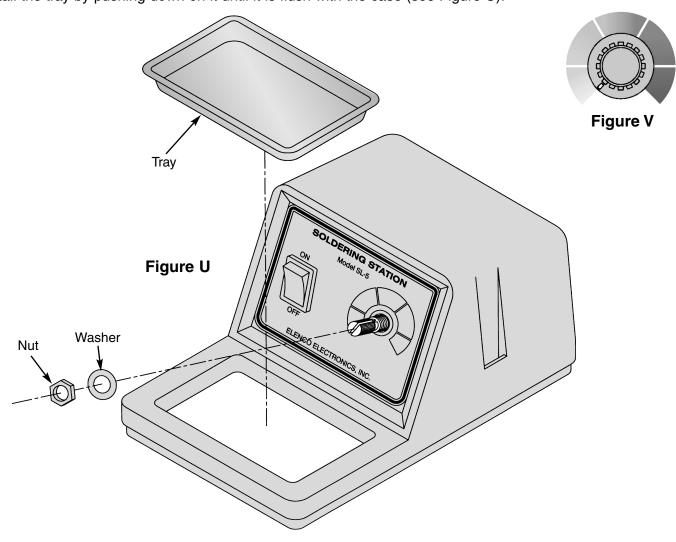




MOUNTING PC BOARD TO CASE

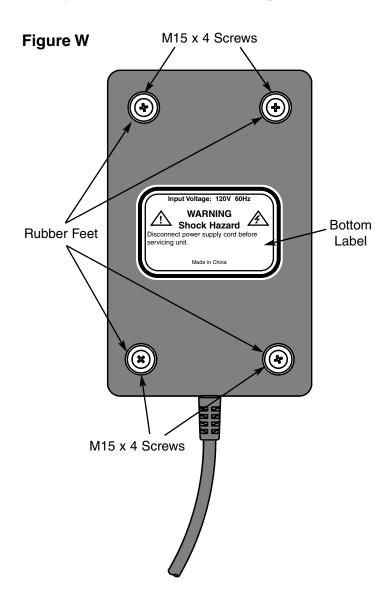


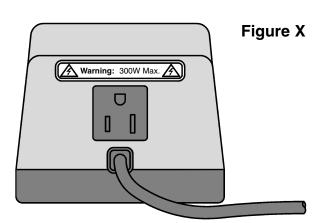
- □ Insert the PC board into the case and then secure the PC board to the case with a washer and nut (see Figure U).
- $\hfill\Box$ Use the cable tie to secure the wires as shown in Figure T.
- ☐ Turn the pot fully counter-clockwise and push on the knob in the position shown in Figure V.
- □ Install the tray by pushing down on it until it is flush with the case (see Figure U).



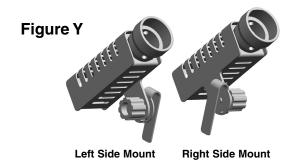
FINAL ASSEMBLY

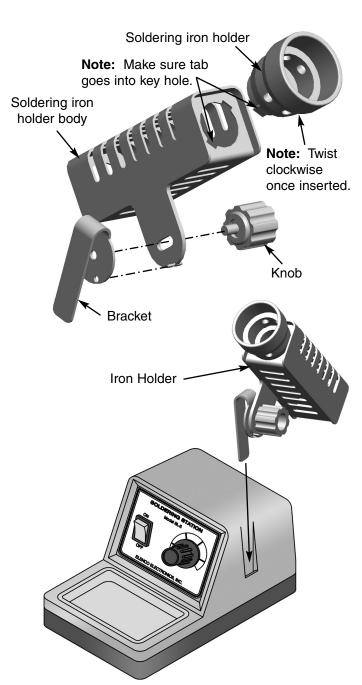
- □ Attach the base to the chassis with four M15 X 4 screws and rubber feet (see Figure W).
- ☐ Apply the bottom label as shown.
- \square Apply the back label as shown in Figure X.





□ Assemble the iron holder as shown in Figure Y below. Insert the iron holder into the slot on either the right or the left side as shown in Figure Y. Set the power switch to the OFF position.

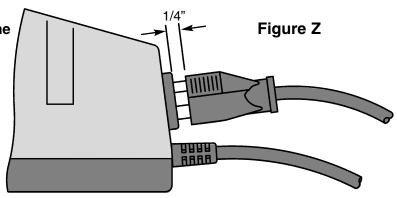




VOLTAGE TEST

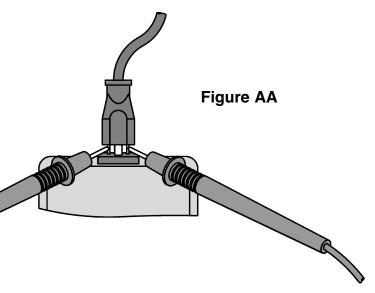
If you do not have a multimeter continue to the OPERATION Section.

□ Place the iron into the holder. Plug your soldering iron cord into the AC receptacle on the back. Adjust it for a 1/4" gap so you can measure the AC voltage, as shown in Figure Z.



□ Set the temperature control to minimum and plug the SL-5 AC cord into an outlet. Turn the power switch to ON and the switch should illuminate. Measure the voltage across the soldering iron plug as shown in Figure AA. Rotate the temperature control knob clockwise and measure the AC voltage. Range 25 ½25 − 120V.

☐ If the measured voltages do not agree, turn the power switch off and unplug from AC outlet. Check the wiring and parts on PC board.

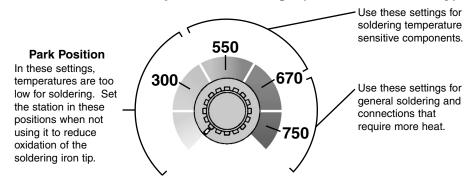


OPERATION

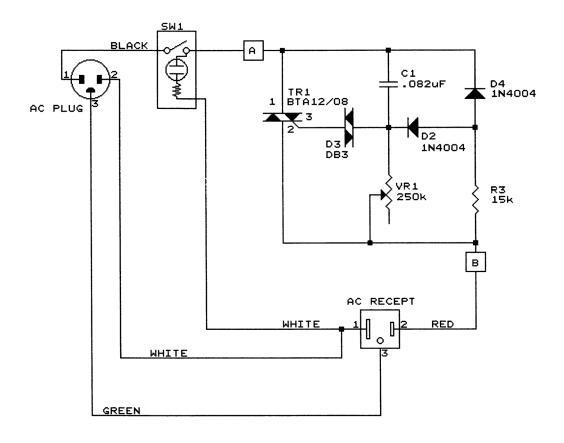
Wet the sponge with preferably distilled or tap water, and then place it into the tray. Plug the soldering iron line cord into the AC receptacle on the back, and then insert it into the holder. Make sure the On/Off switch is set to the Off position and the control knob at minimum. Plug the line cord of the SL-5 into a

120VAC receptacle. Turn the power switch On and the switch should illuminate. Set the temperature control knob midway. Allow the iron to heat up for a few minutes. Now set it to the desired temperature. See the chart for relative temperatures. Using the lowest power setting will protect sensitive devices.

General Areas of Temperature Settings (SR-6 40W iron only)

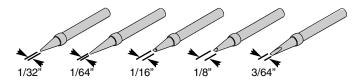


SCHEMATIC DIAGRAM



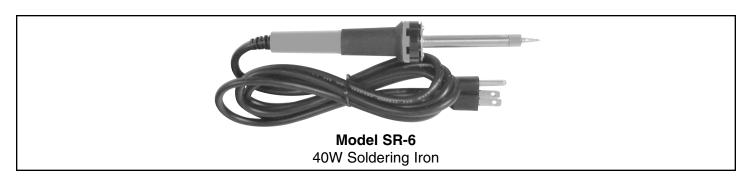
TIP SIZES

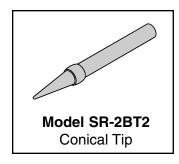
The tip sizes and shapes greatly effects the heating and heat-recovery. Today, tips are manufactured in a variety of different shapes (see figure below). The SR-6 comes with a conical shape, (#SR-2BT2) one of the most common. Having a choice of tip styles allows you to choose the one best suited for your soldering needs. Due to the high heat, removable tips can bond themselves to the heating element if left in place for extended periods. Periodic removal of the tip is therefore advisable.

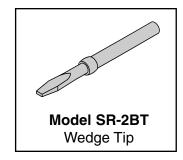


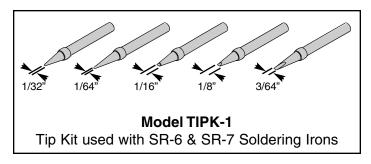
Tip Package Model TIPK-1

Replacements and Optional Solder Aids for SL-5 Series Solder Station

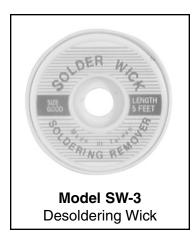


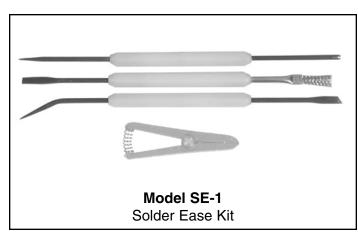


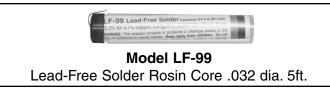


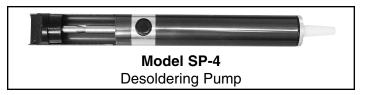




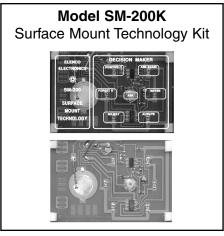














EDUCATION KITS

Complete with PC Board and Instruction Book



Rapid fire or single shot with 2



Requires 9V battery

0-15V Power Supply

A low-cost way to supply voltage to electronic games,



0-15VDC @ 300mA

Christmas Tree

K-14 Produces flashing colored LEDs and three popular Christmas melodies.

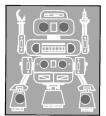
Requires 9V battery

LED Robot Blinker K-17

You'll have fun displaying the

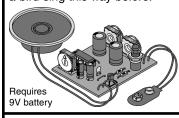
PC board robot. Learn about free-running oscillators.

Requires 9V battery



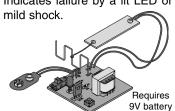
Digital Bird K-19

You probably have never heard a bird sing this way before.



Nerve Tester K-20

Test your ability to remain calm. Indicates failure by a lit LED or



Yap Box K-22A

1 2 3

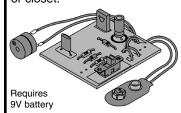
YAP BOX

This kit is a hit at parties. Makes 6 exciting sounds.

Requires 9V battery

Burglar Alarm K-23

Alarm for your car, house, room, or closet.



Whooper Alarm . K-24

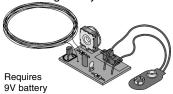
Can be used as a sounder or siren.



Requires 9V battery

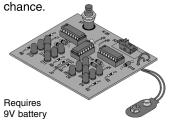
Metal Detector K-26

Find new money and old treasure. Get started in this fascinating hobby.



Pocket Dice K-28

To be used with any game of



FM Microphone AK-710/K-30

Learn about microphones, audio amplifiers, and RF oscillators. Range up to 100 feet. Requires 2 'AA" batteries

Telephone Bug K-35

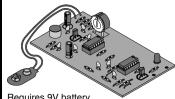
Our bug is only the size of a quarter, yet transmits both sides of a

telephone conversation to any FΜ radio.

No batteries required!

Sound Activated Switch K-36

Clap and the light comes on . . clap again and it goes off.



Requires 9V battery

Lie Detector K-44

The sound will tell if you are lying. The more you lie, the louder the sound gets.

Requires 9V battery

Motion Detector AK-510

Use as a sentry, message minder, burglar alarm, or a room detector.

Requires 9V battery



Training course incl.

Two IC AM Radio AM-780K

New design - easy-to-build, complete radio on a single PC board. Requires 9V battery.



Transistor Tester **DT-100K**

Test in-circuit transistors and diodes.



Telephone Line Analyzer TWT-1K

A telephone line analyzer kit that tests active phone lines with RJ-11 or RJ-45 modular jacks.



Variable Power Supply XP-720K

Three fully regulated supplies: 1.5-15V @ 1A, -1.5 to -15V @ 1A or (3-30V @ 1A) and 5V @



QUIZ

 1. The solder supplied in this ki is comprised of what two materials? A. Gold and copper B. Tin and copper C. Zinc and copper 	 6. Solder wick is used to □ A. remove solder. □ B. solder in small parts. □ C. cleaning the soldering iron tip. □ D. removing flux.
☐ D. Lead and aluminum	7. A cold solder joint is caused by
2. What type of flux should be used in electronics?	☐ A. a solder bridge.
□ A. Chloride	☐ B. using 60/40 solder.
□ B. Organic	☐ C. insufficient heat.
□ C. Rosin	□ D. acid core solder.
□ D. Corrosive	_ B. doid ooro coldon
_ 5. Cococ	8. When two adjacent foils accidentally touch, it is
3. When working on PC boards, what wattage range	called
of iron is ideal?	□ A. a jumper.
☐ A. 15-40 watts	□ B. a blob.
☐ B. 50-100 watts	☐ C. a solder hole.
☐ C. 1-10 watts	□ D. a solder bridge.
☐ D. 100-200 watts	Ç
	9. What ratio has the greatest amount of tin?
4. Tinning the soldering tip will prevent it from	□ A. 20/80
☐ A. heating.	□ B. 40/60
☐ B. melting.	□ C. 50/50
□ C. soldering.	□ D. 60/40
☐ D. oxidizing.	
	10. A good solder connection should be
5. Proper solder adhesion requires that the metal	☐ A. dull and rough.
surface to be	☐ B. shiny, bright and smooth.
☐ A. solder free.	□ C. lumped around the connection.
☐ B. clean.	\square D. soldered on one side of the connection.
□ C. greasy.	
□ D. cold.	

Answers: 1. B, 2. C, 3. A, 4. D, 5. B, 6. A, 7. C, 8. D, 9. D, 10. B

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